

L Number	Hits	Search Text	DB	Time Stamp
1	246	438/256, 279, 399, 586, 597, 598, 599, 602, 624, 634 and @ad<=20011207 and enclos\$6	USPAT61, 767, US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT;	2003/10/15 09:23.
2	0	438/256, 279, 399, 586, 597, 598, 599, 602, 624, 634 and @ad<=20011207 and enclos\$6 and (mesa adj region)	USPAT61, 767, US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT;	2003/10/15 09:23.
5	1	257/\$.ccls. and @ad<=20011207 and enclos\$6 and (mesa adj region) and (second adj insulat\$6) and (cap\$6 adj (layer or film))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT;	2003/10/15 09:19
4	1	438/\$.ccls. and @ad<=20011207 and enclos\$6 and (mesa adj region) and (second adj insulat\$6) and (cap\$6 adj (layer or film))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT;	2003/10/15 09:22
3	2	438/256, 279, 399, 586, 597, 598, 599, 602, 624, 634 and @ad<=20011207 and enclos\$6 and (second adj insulat\$6) and (cap\$6 adj (layer or film))	USPAT61, 767, US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT;	2003/10/15 09:23.
6	1	semiconductor and @ad<=20011207 and enclos\$6 and (mesa adj region) and (second adj insulat\$6) and (cap\$6 adj (layer or film))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT;	2003/10/15 09:22
8	2	(438/256, 279, 399, 586, 597, 598, 599, 602, 624, 634 and @ad<=20011207 and (second adj insulat\$6) and (cap\$6 adj (layer or film))) and enclos\$6	USPAT61, 767, US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT;	2003/10/15 09:23.
7	95	438/256, 279, 399, 586, 597, 598, 599, 602, 624, 634 and @ad<=20011207 and (second adj insulat\$6) and (cap\$6 adj (layer or film))	USPAT61, 767, US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT;	2003/10/15 09:28.
-	163	(438/256).CCLS.	US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT;	2003/04/16 13:18
-	296	(438/279).CCLS.	US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT;	2003/04/16 13:19
-	166	(438/399).CCLS.	US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT;	2003/04/16 13:19
-	2040	(438/586).CCLS.	US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT;	2003/04/16 13:19
-	414	(438/597).CCLS.	US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT;	2003/04/16 13:19
-	211	(438/598).CCLS.	US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT;	2003/04/16 13:19

